ABSTRACT OF THE DISCLOSURE

It is an object of the present invention to provide a method for manufacturing a multi-layered unit for a multi-layered ceramic electronic component which can reliably prevent short circuit failure from occurring in a multi-layered ceramic electronic component.

According to the present invention, a multi-layered unit for a multi-layered ceramic electronic component is fabricated by printing a conductive paste containing an acrylic system resin as a binder and at least one solvent selected from a group consisting of limonene, α-terpinyl acetate, I-dihydrocarvyl acetate, I-menthone, I-perylil acetate, I-carvyl acetate, and d- dihydrocarvyl acetate as a solvent on a ceramic green sheet containing a butyral system resin as a binder in a predetermined pattern, thereby forming an electrode layer.